

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s):	Stephen W. Bedell	Examiner:	Heather A. Doty
Serial No.:	10/710,826	Group Art Unit:	2813
Filed:	August 5, 2004	Attorney Docket No:	FIS920040069
Title:	METHOD OF FORMING STRAINED SILICON MATERIALS WITH IMPROVED THERMAL CONDUCTIVITY		

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**AMENDMENT AND RESPONSE**

Mail Stop Non-Fee Amendment  
Assistant Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This paper is submitted in response to an Office Action mailed April 11, 2006 by the United States Patent and Trademark Office in connection with the above-identified Application. A response to this April 11, 2006 Office Action is due by July 11, 2006. Therefore, this response is being timely filed.

**Amendments to the claims** begin on page 2 of this paper.

**Remarks** begin on page 5 of this paper.